

**TRANSMITTAL**

Electronic Version v1.1

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Title of Invention	ULTRA-LOW IMPEDANCE POWER INTERCONNECTION SYSTEM FOR ELECTRONIC PACKAGES							
Application Number: 10/036957 Date: 2001-12-20 First Named Applicant: Mr. Joseph T. DiBene II. Confirmation Number: 4590 Attorney Docket Number: INCEP.017A								
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